

Hard Coating is Because of Oppositely Worked Force-Energy Behaviors of Atoms

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Abstract –Coatings of suitable materials having thickness of few atoms to several microns on the viable substrates are the basic need of society and they attend the regular attention of scientific community working in various fields of science and technology. Decorative and protective coatings, transparent and insulating coatings, coatings of medical implants and surgical instruments, coatings for drug delivery and security purposes, ultra-precision machine coatings and coatings of miscellaneous uses are in the routine demand of research and commercial objectives. Different hard coatings develop under the significant composition of differently natured atoms where their force-energy behaviors as per recovering of transition states provide the provision for electron (of outer ring) belonging to gas atom to undertake another clamp of unfilled energy knot (of outer ring) belonging to solid atom. Set process conditions switch force-energy behaviors of differently natured atoms as per at the ground surface where they nearly worked oppositely to the original state behaviors. Different natured atoms develop structure in the form of hard coating by locating the ground point between original points where gas atoms increase potential energy under the decreasing levitational force at electron levels while the solid atoms decrease potential energy

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under the decreasing gravitational force at electron levels. Ti-atom to Ti-atom binding is through the difference of expansion of their lattices when one atom is just landing on the appropriately already landed atom where the adhered nitrogen atoms nearly incorporated in their interstitial sites. Under suitable set parameters, different nature atoms deposit in the form of coating at substrate surface in the deposition chamber of certain energy source-based technique. In random arc-based vapor deposition system, depositing different natured atoms at substrate surface depends on the input power where involved non-conserved energies engaged the non-conservative forces to keep the structure adhered. Different properties and characteristics of hard coatings emerged as per engaged forces under the set conditions of involved energy. The present study sets new trends not only in the field of coatings but also in the diversified class of materials and their counterparts, wherever, atoms recall their roles.

Keywords: Atomic behavior; Hard coating; Expansion and contraction; Force-energy behaviors; Surface and interface

1. Introduction

Hard coatings are the integral part of scientific research for researching and technological advances. Marketable hard coatings for different purposes are learnt routinely where their ingredients and deposition technique are in the hot topics. In this context, several materials involving different ingredients and deposition techniques are available in the literature discussing and explaining their deposition history along with the features of substrate material. In coatings, a minute deposited quantity of materials over less-important or not practically viable material solves the purpose of giving the value-added results.

A variety of techniques are involved to deposit different sorts of hard coatings at the surface of suitable substrates. Coatings are mainly employed with two targeted approaches; in the first case, the potential use of external coated part, which is not subjected to a great deal in the uncoated case and, in the second case, potential use of internal surface where inner uncoated surface of material was not the subject of great concern but, on coating, it became a great deal. Overall, coating the surface of a certain

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substrate results into deliver its different behavior of functioning, often in an astonishing way.

Solid atoms of unfilled states do not elongate and those belonging to inert gases split under the excess propagation of photons characteristic current [1]. A neutral state silicon atom transformed heat energy into photon energy as discussed elsewhere [2]. Atoms of suitable solid behavior evolve structures of different dimension and format as per the nature of built-in electronic gauge where conservative forces involved to execute confined inter-state electron-dynamics [3]. The origins of atoms of certain elements to be in gas state while the origins of atoms of certain elements to be in solid state are discussed elsewhere [4]. A gas state carbon atom originates several different physical behaviors, which is under the involvement of non-conserved energy where confined inter-state dynamics of electron to attain its certain state engaged non-conserved forces as well [5]. Depending on the atomic behavior of tiny sized particles, their role for nanomedicine can either be beneficial or harmful [6].

Developing different hierarchical tiny particles under varying conditions of the process is under differently attained dynamics of gold atoms [7]. A monolayer triangular-shaped tiny particle was considered as the model system discussing the elongation behavior of one-dimensional arrays of gold atoms and their conversion into structure of smooth elements under the joint application of surface format force and travelling photons of adequate wavelength [8]. At suitable precursor concentration, many tiny particles shape-like equilateral triangle developed as discussed elsewhere [9]. Shapes of tiny sized particles and large sized particles were controlled under the application of different ratios of pulse OFF to ON time [10]. Particles of different anisotropic shapes developed in less than millisecond time [11]. Developing tiny sized particles of certain shape tapped in different precursors [12]. Predictor packing while developing highly geometric anisotropic gold particles is discussed elsewhere [13] where controlled force-energy behaviors regulate the shape.

Different behaviors of tiny grains carbon films registered under Raman spectroscopy and energy loss spectroscopy indicated several phases of tiny grains [14]. Switching morphology-structure of grains and crystallites under a bit altered locally operating

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parameters in developing carbon films is discussed elsewhere [15]. Under varying chamber pressure, a discernible change in the morphology and growth rate of carbon films was observed [16].

While depositing TiN coatings on different substrates under varying process conditions while employing a technique known as ‘cathodic arc physical vapor deposition’, a different morphology-structure along with hardness, surface roughness, friction coefficient, adhesion strength and overall performance of coated tools were studied [17-28]. In addition to these studies, there are several other available studies in the literature targeting TiN coatings along with their processing techniques and analyses [29-36]. In addition to TiN coating, different types of hard coatings developed under various employed conditions have also been published extensively [37-48]. The basic idea discussed in those studies is related to the properties and characteristic of deposited coatings, which are subjected mainly to the change of process parameters, type of material and processing approach.

The prosperous assembling of colloidal matter into meaningful structure will result into deal atoms and molecules as tomorrow’s materials [49] and understanding in the individual dynamics of tiny sized particles formation is essential before enabling their assembling to the useful large sized particles [50].

In addition to the discussed scientific details available for hard coatings, coatings are in the way to express relation between comprised atoms. This study reports the fundamental aspects of developing hard coatings with special emphasis on depositing TiN coating at a high-speed steel (HSS) disc while employing random arc-based vapor deposition technique. This work presents the fundamental aspects of depositing hard coating, in general, and investigating mechanism of developing TiN coating, in specific.

2. Experimental details

HSS discs were utilized as a substrate material for the deposition of TiN while employing the commercially available coating unit known as ‘cathodic arc physical vapor deposition technique’, which is now termed as ‘random arc-based vapor deposition technique’ in the present study. After the required cleaning, the samples

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having diameter: 10 mm and thickness: 6 mm were loaded in the coating system mark Hauzer Techno Coating (HTC) 625/2 ARC. The complete deposition procedure along with metallographic process of samples have been described in the earlier work [28]. Surface and interface cross-sectional views were captured by using field emission scanning microscope (FESM known as FE-SEM, Model LEO-1525). The thickness of the deposited coatings was measured under the application of field emission scanning microscope and through the captured fractured cross-sectional image of the deposited coating on HSS substrate. Prior to coat (deposit) TiN on treated HSS disc, an inter-layer of Ti-atoms was deposited for the period of 15 minutes process time. The purpose of depositing inter-layer was to enhance the adhesion strength of the following TiN coating. So, instead of nitrogen gas an inert gas was regulated through mass flow controller to incorporate into the deposition chamber to ignite the arc. At the start of depositing inter-layer, chamber pressure was 5×10^{-6} mbar. While depositing inter-layer, 50 sccm nitrogen gas flow rate was maintained by mass flow controller meter. To deposit TiN in the form of coating, substrate temperature was maintained at 300°C where N gas flow rate was 250 sccm. The bias voltage was 50 volts where rotational speed of the substrate holder was set 60%. Input current for igniting arc to eject Ti-atoms from the target was 100 A. Total duration of the deposition process was set 90 minutes.

3. Results and discussion

Figure 1 (a) shows surface topography of deposited TiN coating on HSS disc where coating is partially covered with macrodroplets (MDs), size ranging from few hundred of nanometers to few microns. The distribution of MDs is uniform throughout the surface of deposited coating. A large sized macrodroplet (MD) in the central vicinity of deposited coating shown in Figure 1 (a) shows mapping of the region where the concentration of both Ti and N atoms is appeared to be in different colors. Figure 1 (b) shows fractured cross-sectional view of the coating where initially deposited Ti inter-layer shows thickness less than one micron. Atoms of Ti inter-layer first adhere to surface atoms of

substrate under the favorable conditions as observable in the texture of few nanometers thick deposited layer between the substrate and deposited TiN coating.

Substrate surface comprises different elements like W, Mo, Cr, V, C and Fe, which solve the initial purpose to adhere Ti-atoms to the substrate [17, 24]. Ti-atoms bound to substrate surface under the certain conditions of depositing inter-layer as discussed in the experimental section. The nature of substrate surface dealt their atoms of different elements in the manner where certain arrested force-energy behaviors introduce their appreciable binding to the depositing few nanometers thick Ti-atoms layer. This inter-layer workout for the adhesion strength of afterward depositing coatings needs to be investigated further. Some preliminary detail regarding adhesion strength of TiN coating deposited under certain conditions in random arc-based vapor deposition system is discussed elsewhere [26, 28].

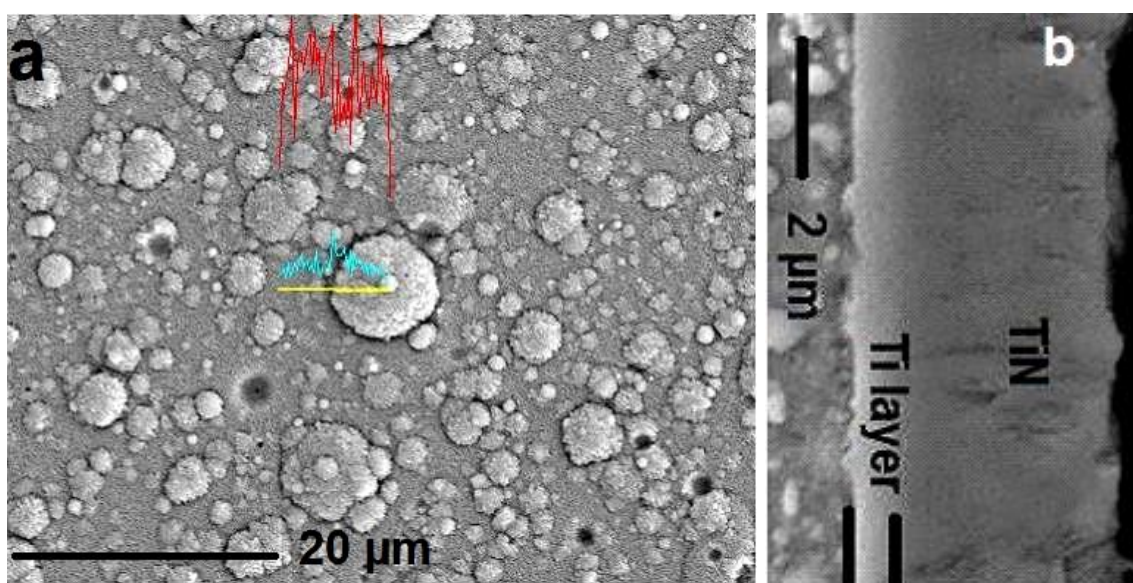


Figure 1: (a) topographic view of TiN coating on HSS disc and (b) few hundred nanometers thick titanium inter-layer shows contrast with respect to afterward deposited TiN coating having thickness $\sim 4 \mu\text{m}$

Figure 2 shows the mapping of Ti-atoms found in the deposited TiN coating at the point of its MD (in Figure 1a) in the form of histogram where its content is around 70%. This indicates that the portion of coating covered by Ti-atoms in top front surface coating not only contained 70% of its content but the distribution of Ti-atoms in MD is also remained uniform. This indicates that MD contained less concentration of N-atoms.

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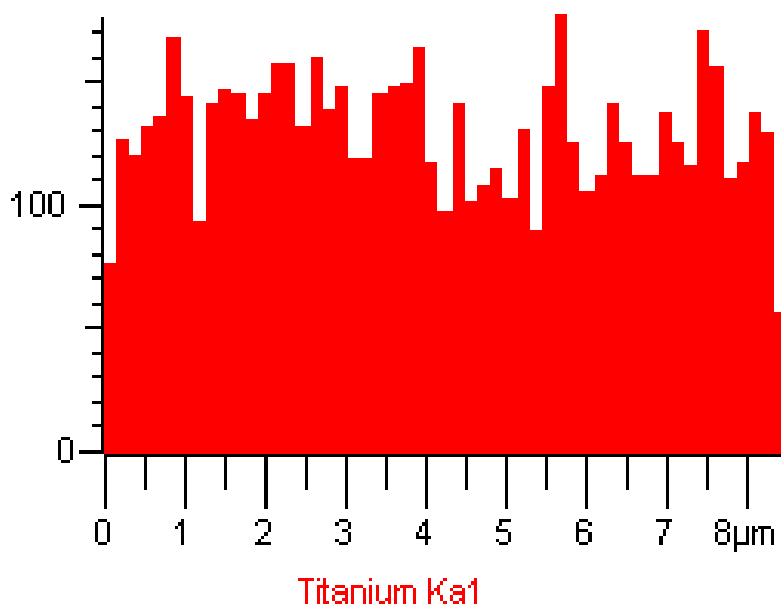


Figure 2: Mapping of Ti-atoms distribution along with the ratio of content

Figure 3 shows the mapping of N content in TiN coating in the form of histogram, which is around 30% at the central point of MD shown in Figure 1 (a). This indicates that the portion covered by N-atoms in top front surface of coating not only contained 30% of its content but also contained uniform distribution. However, the distribution of N-atoms in the coating is not appeared in the dense manner. This describes that MD contained approximately three times less concentration of N-atoms as compared to Ti-atoms.

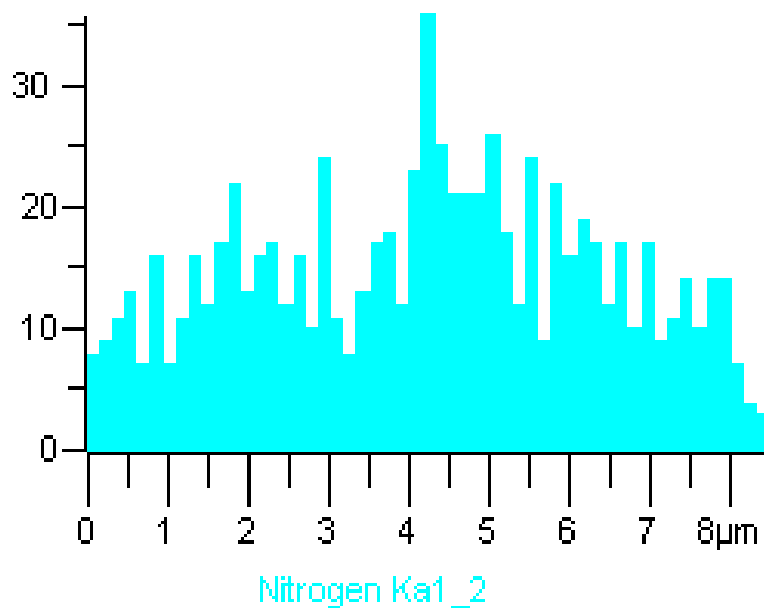


Figure 3: Mapping of N-atoms distribution along with the ratio of content

There are several studies which investigated reduction of MDs in the hard coatings under varying the process parameters in suitable vapor deposition technique along with different employed strategies as not viable for the ultra-precision machine coatings [17-20, 23-25].

Hard coatings mainly fall in the category of refractory materials and they are no more the candidates of conductive behavior despite of the fact that their major component still involved the metallic nature atoms. On adherence of gas atoms to metallic atoms, the resulted coatings become poor in conduction and they work nearly as an insulator where field of propagating photons (having characteristic of current) is interrupted to a large extent. This is because of locking inter-state electron gaps for metallic nature atoms by means of incorporating gas atoms. These result into develop disordered structure of the resulted coating. In the case of disordered structure, it is only within the short-range order. The incorporated N-atoms built the bridges *via* their certain electrons where they undertake another clamp of unfilled energy knot belonging to outer rings of Ti-atoms. This resulted into lower the propagation of photons. A detailed study presented discusses the significance of inter-state electron gaps in atoms of different elements [1]; propagation of photonic current (or photons having wavelengths other than that of current) require no more the band gap between conduction band and valence band. This indicates that science of semiconductor materials or other types of materials require new and fresh thoughts to explain the origin of their different hidden phenomena.

In random arc-based vapor deposition system, atoms of Ti (or other metallic nature atoms) are ejected from the front-surface of their targets where arc (in different shape) is utilized to eject atoms under the supply of high energy depending on the strength of applied field per unit area (or volume) attached with its coating technology unit. At high concentration of N-atoms, a random arc is steered to eject Ti-atoms both in atomic form and tiny-sized cluster (droplet) depending on the nature of Ti targets along with employed conditions of vapor deposition process. The basic layout of ejecting Ti-atoms and entering N-atoms to deposit TiN coating is sketched in estimation as shown in Figure 4.

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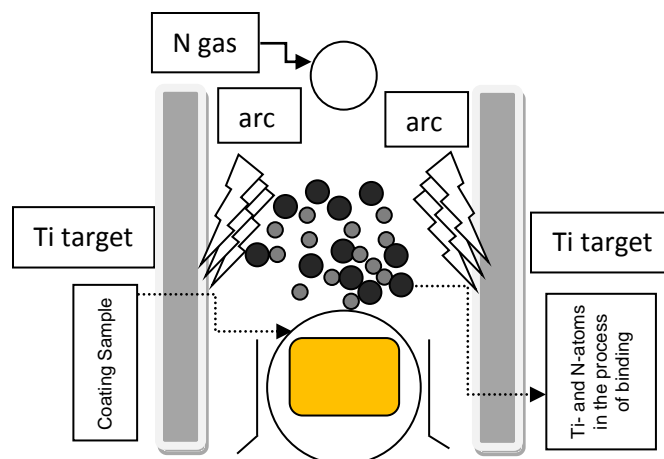


Figure 4: The basic layout of depositing Ti-atoms and N-atoms to develop TiN coating at the surface of HSS substrate

A newly observed atomic structure for atoms of Ti and N elements is shown in Figure 5. The tiniest sized particles called (named) electrons are filled in the hollow space formed by the inter-crossed overt photons (with understanding) under their certain symmetry where wavelength of those (overt) photons is in the current (conventionally known as electric or electronic current). A detailed study discussed the atomic structure of atoms belonging to different elements along with their origins to be in gas state and solid state [4]. A separate study discussed the lattice and atomic structure of different state carbon atoms [5]. In the case where electrons don't fill the inter-crossed regions of energy knots (hollow space), they are related to (termed as) the unfilled states for those atoms. For Ti-atom, total 32 states of electrons are available, but 24 states are filled by the tiniest sized particles (electrons) while 8 states are remained unfilled. In the case of inner unfilled states of the atom, they are being remained pressed by the covered filled states as indicated in Figure 5. Both filled and unfilled states of Ti-atom are formed (constructed) by the inter-crossed overt photons having their dedicated length. The required number of overt photons are being inter-crossed with full understanding of their atoms related to each element by involving the three-dimensional space. However, unfilled states are belonged to outer ring where electrons don't occupy the position, which are at the terminals of certain chain of states as shown in Figure 5.

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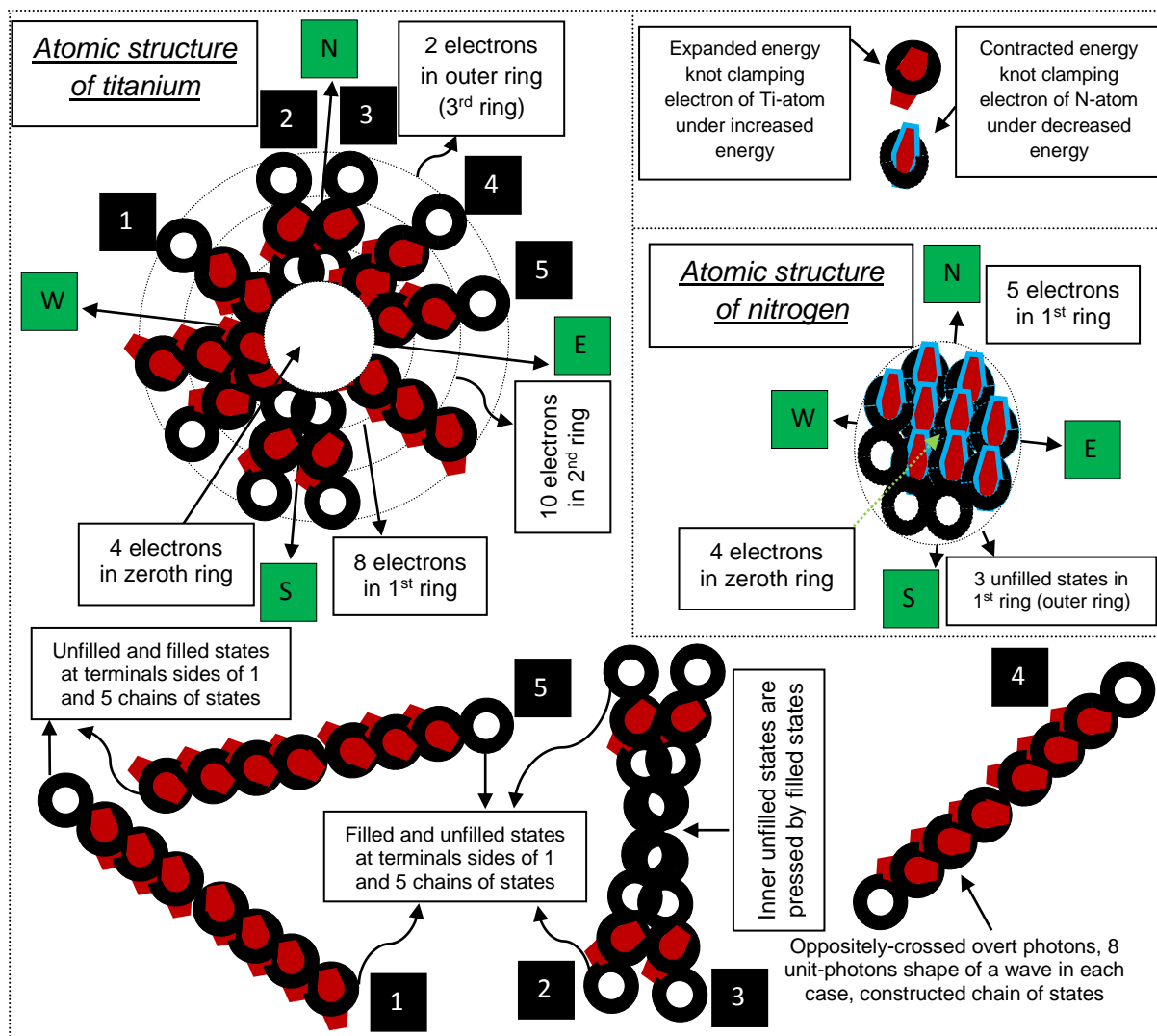


Figure 5: newly observed atomic structure of atoms belonging to Ti and N elements; involved different chain of states are shown at bottom indicating filled, unfilled states and pressed states for Ti-atom

Oppositely-sided crossed two overt photons comprising eight unit-photons construct a chain of filled and unfilled states of electrons. As shown in the bottom part of Figure 5 where five such shapes are drawn and their precise inter-crossing at a common centre forms the lattice of Ti-atom in which 24 states are remained filled. Expanded and contracted energy knots (in estimation) clamping electrons in Ti-atom and N-atom, respectively, are also shown in Figure 5. Filled states of outer ring in the atoms of solid and gas behaviors donate the positive valency and negative valency, respectively. For the case of Ti atom, valency is +2, so, it has '8' unfilled states. In the case of nitrogen

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atom, valency is -3, so, it has '5' unfilled states. Hence, negative sign for valency in gas behavior atoms indicates their ground point at above average level of ground surface and positive sign for valency in solid behavior atoms indicates their ground points at below average level of ground surface. Inner four electrons of atoms belonging to each element form the zeroth ring, whereas, others are related to the available consecutive rings as discussed elsewhere [4].

In different coating technology units, regardless of that, required numbers of atoms per unit area or volume are being deposited under set parameters of the process, their involved energy is based on individually attained dynamics plus electron-dynamics, which is the key to regulate their structure, so, there is emergence of properties and characteristics of their resulted coating. However, it appears that evolving structure of TiN coating in the order of certain homogeneity is within the short-range order. Therefore, the deposited coating is developed mainly under the mixed behavior of structure evolution. Each Ti-atom only occupies two electrons in the outer ring. This low number of its filled states enables it to occupy many unfilled states of outer ring since its existence. Ti being a solid atom is supposed to has its unfilled states at above east-west poles, both at left and right sides of the north-pole. Because atoms of Ti element are belonged to grounded format where electrons of filled states (in the outer ring) are to be remained at below their east-west poles along the south-pole while undertaking their original solid behavior. On the other hand, five filled states in outer ring of N-atom allow a smaller number of unfilled states in the outer ring. In this context, a N-atom contains several filled states of outer ring where majority of the electrons (filled states) are expected to be at above the east-west poles along the north-pole while in each dedicated state. This is because of the gas nature of N-atom. Further detail of the origin of gas atoms belonging to some elements was discussed [4]. The availability of several unfilled states of outer ring in Ti-atom provides provision to work for electrons of filled states of outer ring in N-atom where targeted electron (of gas atom) is being clamped by another clamping of energy knot (of solid atom). The double-clamping of energy knot to the electron of N-atom is by means of energy knot clamping unfilled state of outer ring in the Ti-atom. But the mechanism of double clamping of energy knot by the electron is by

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means of suitable transition of both gas and solid atoms. Atoms when are in a certain transition state adjust potential energy of their electrons as per exertion of the orientating force [4]. Therefore, two different nature atoms (Ti and N) develop affinity in terms of strong binding under a suitable reaction (fast interaction).

A metallic target developed under the solidification of its transition state atoms, most probably, when they were under their re-crystallization transition state. The processed ore of metallic target is at the level of ground surface but their atoms in original solid state are to be at the below level to ground surface. Similarly, gas atoms compressed in the container are in the re-crystallization transition state as well at the level of ground surface, whereas, they are in original gas state at the above level to ground surface. On ejecting of solidified nature atoms from the target and flowing of the compressed gas nature atoms from the container, they are again in transition to restore their original states. So, in the attempt of reviving their original state behaviours, they react (fast interact) just at above the substrate of their deposition. At instant of their reaction (fast interaction), different natured atoms are in their nearly opposite switched force-energy behaviours. Here, under their suitable interactions, electrons of gas atoms enter to unfilled states of solid atoms. In both cases, entering electrons of filled states and clamping energy knots of unfilled states, they are belonged to the outer ring of their atoms. Gas atoms when are in the re-crystallization state, their electrons go downward sides under infinitesimal displacements where they decreased their levitational force by gained potential energy. But, electrons of the gas atoms are still more than 50% to upward sides at mid of their clamped energy knots. Solid atoms when are in the re-crystallization state, their electrons go upward sides under infinitesimal displacements where they decreased their gravitational force by losing the potential energy. But, electrons of the solid atoms are still more than 50% to downward sides at mid of their clamped energy knots. So, when two different natured atoms reach to just in neutral state, electrons of the gas atoms undertake clamps of energy knots belonging to solid atoms in each case where clamping of one more energy knot to each electron (of the gas atom) is belonged to the solid atom. When gas and solid atoms are just in attaining their neutral states, electron of the gas atom undertakes one more clamping of energy

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knot belonging to solid atom by visualizing the exerting forces of its relevant poles. Those different natured atoms remain in restoring their original states by remaining adhered, thus, keep continuing to introduce the hard features.

Atoms of metallic targets are already in the contraction of energy knots clamping electrons because, they are not grounded below the ground surface now. On the other hand, entered gas atoms to the chamber are in the expansion of energy knots clamping electrons because, they are at ground surface now instead of being at above ground surface through the given pressure for their entering to the deposition chamber. Therefore, different natured atoms switched force-energy behaviors nearly in opposite manner. Just at instant of recovering original behaviors, they reach to bind upon suitable coinciding where targeted electron of gas atom undertakes another clamp of targeted energy knot (clamping to unfilled state) of solid atom. Therefore, solid atoms of Ti have already done work negatively (arriving near to ground surface from the south-side) while gas atoms of N have already done work positively (arriving near to ground surface from the north-side). On recovering the state behaviors of two differently natured atoms to be just in neutral state from their re-crystallization states, they switched their force-energy behaviors where work done by the gas atom is negative while work done by the solid atom is positive. So, they react to undertake double clamping of the suitable electron (of the gas atom) through suitable unfilled state (of the solid atom).

Ti metal is known in metallic character where filled state electrons of atoms remain grounded under attaining the maximum gravitational force, so, the maximum expansion of their clamped energy knots, also. Thus, electrons of Ti-atoms keep the original ground point at below ground surface under the normal condition. On the other hand, a N-atom belongs to gas behavior, which remains in the air (at above average-leveled ground surface) under the engagement of space format force exerting at electron levels, thus, its electrons possess original ground point at above ground surface. The electrons of N-atoms keep their ground point at above ground surface because of the maximum contraction of their clamped energy knots where the maximum orientating levitational force is being exerted at electron levels. Therefore, in their joint deposition while

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employing a suitable coating technology unit, electron of outer ring belonging to N-atom clamp by another energy knot clamping to unfilled state of outer ring in Ti-atom. Given energy in the deposition chamber enables another clamping of the energy knot to a suitable electron of gas atom and through energy knot of a suitable unfilled state of solid atom where energy is involved to engage the force. This results into search their ground point neither at above ground surface nor at below ground surface. In the search of attaining their ground points, they mutually get ready for the common ground point at the surface of depositing substrate, which becomes nearly at mid-point of two different ground points; at above ground surface (in gas atoms) and at below ground surface (in solid atoms). Under the tailored process parameters of deposition, structure of hard coating exhibits high hardness because of the maximum ordering of different nature transition state atoms where their attained mid-points remained ordered to a large extent.

The electrons of N-atoms undertake double clamps of energy knots while visualizing to unfilled states of Ti-atoms where gas state atoms are being uplifted while solid ones are being grounded. Suitable transition state atoms undertake double clamps of targeted energy knots (belonging to solid atoms) to targeted electrons (belonging to gas atoms) under their favorable coinciding. The mechanism of double clamping of suitable energy knots to suitable electrons of N-atoms is grounded forcefully by the Ti-atoms (through suitable energy knots clamping unfilled states) as shown in Figure 6. Binding of Ti-atom to Ti-atom under the application of an electron (belonging to less expanded Ti-atom just landing) to undertake another (double) clamp of energy knot (belonging to more expanded Ti-atom already landed) is also shown in Figure 6 where N-atoms mainly position at interstitial sites of Ti-atoms. Under the action of tailored force-energy behaviors of N-atoms and Ti-atoms, they react, which results into their binding to develop TiN coating at surface of the substrate. Because, solid atoms in their original state behavior undertook fully orientated gravitational force, which is due to their grounded ground points under fully gravitized behavior exerting at electron levels, thus, their electrons gained the maximum potential energy where clamped energy knots also undertook the maximum expansion. So, energy knots constructing unfilled states in

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those atoms also expanded maximally. But, gas atoms in their original state behavior undertook fully orientated levitational force, which is due to their ground points at above ground surface under fully levitized behavior exerting at electron levels, thus, their electrons gained the minimum potential energy where clamped energy knots also undertook the maximum contraction. So, energy knots constructing unfilled states in those atoms also contracted maximally.

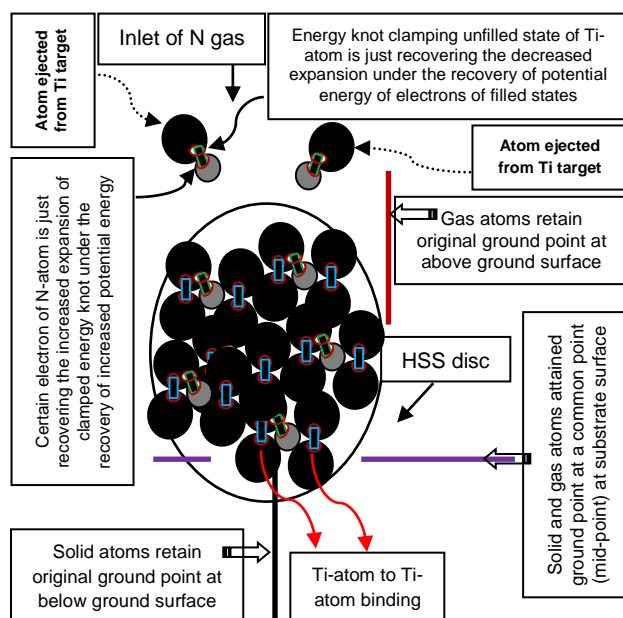


Figure 6: Mechanism of double clamping of suitable energy knots to suitable electrons of gas atoms through suitable energy knots clamping unfilled states of solid atoms along with Ti-atom to Ti-atom binding

On landing a Ti-atom at substrate, it recovers its transition state into original solid behavior where electrons start to gravitize. But prior to fully gravitize, an adequate expansion of the lattice under increased (gained) potential energy is taken place. However, Ti-atom after landing attains ground point at the surface of previously landed atom, so, it kept the lattice in less expansion. Therefore, a certain electron of less expanded land Ti-atom (where it is pointing toward the downward side) enters to a suitable vacant energy knot of a more expanded landed Ti-atom (where it is pointing toward the upward side). This results into bind the two identical atoms. Now, forcefully grounded nitrogen atoms tend to recover state to go into original gas behavior where their certain electrons are entered to certain vacant energy knots of Ti-atoms from the

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back-side. In this way, nitrogen atoms are trapped at interstitial position of the Ti-atoms. Binding of nitrogen atoms at interstitial positions of bound Ti-atoms is also shown in Figure 6. Atoms of nitrogen (or other suitable gas elements) and titanium (or other suitable solid elements) engage energy under the exerting forces of fixed poles of electrons when they in their original behaviors. But, the situation becomes different when they undertake certain transition (liquid) state where in the solid atoms, energy is directly proportional to the exerting gravitational force exerting at electron levels, whereas, in the gas atoms, energy is inversely proportional to the levitational force exerting at electron levels. Further detail of energy-force (or force-energy) relationship in the case of gaseous state atoms and solidus state atoms is given elsewhere [4].

The similar sort of mechanism is being anticipated in bi-metallic composition with gas behavior atoms, for example, TiAlN. Again, low measured-hardness coating of chromium nitride (compared to TiN) involves the mechanism of binding their different nature atoms under similar lines where high probability of binding is involved as Cr-atom contains many unfilled states in the outer ring (compared to Ti-atom). That's why CrN coating exhibits low surface roughness as compared to TiN coating [28] and, also, because of greater level of homogeneity of binding atoms while evolving structure. A similar approach may be validated to explore the science of other hard, moderate hard and even less hard (soft and porous) coating materials. A different originating scientific mechanism may be anticipated in the case of TiCN coating and because of involving the carbon atoms, which requires additional lines to express the science of their synthesizing materials. Reacting of gas atoms and solid atoms endorse engaging of force exerting by their electrons under the adjustment of expansion and contraction of clamped energy knots, respectively. In this case, the energy is being involved. Therefore, developing hard coating is related to non-conserved energy where non-conservative frictional forces are engaged to sustain the structure of coating. However, where the force element is involved first, the energy is being engaged as for the case of silicon atoms [2]; conservative forces are involved to configure the energy in the form of forcing energy (photon). A photon wavelength in the characteristic current is discussed elsewhere [1]. A unit-photon and an overt photon are discussed elsewhere [2]. The

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origin of atoms of different elements to be in gas state and to be in solid atoms is discussed elsewhere [4]. Conversion of gas state carbon atom into different states carbon atoms along with the binding of identical state carbon atoms is also discussed [5].

4. Conclusions

This is the provision of solid atom just recovering the transition state which allocates energy knot belonging to suitable unfilled state of outer ring to clamp certain filled state electron of gas atom when just recovering the transition state also. The reacting of gas atom while ground point is just at ground surface (instead of at above ground surface) is because of increased orientating gravitational force of its electrons where their potential energy is increased resulting into increase the expansion of clamped energy knots. The reacting of metallic atom while the ground point is just at ground surface (instead of at below ground surface) is because of decreased orientating gravitational force of its electrons where their potential energy is decreased resulting into decrease the expansion of clamped energy knots. This results into the binding of two different natured atoms at a common ground point, which is the mid of ground points of gas atom and solid atom when they were in their original state behavior, thus, engaging force as per involved energy to sustain their binding, which is working as a hard coating.

To be undertaken by the electron (belonging to filled state of gas atom), one more clamping of energy knot (belonging to unfilled state of solid atom) is through the mutual adjusting expansion-contraction of their lattices, resulting into deposit structure of hard coating, which is known since antiquity.

The underlying science of developing hard coating is in the manner that atoms of solid behavior perform negative work when undertaking the certain transition state as they attain ground points at the level of ground surface and atoms of gas behavior perform positive work when undertaking the certain transition state as they attain ground points at the level of ground surface. For developing hard coating, gas atoms when just recovering transition state of increased orientating gravitational force react to solid atoms when just recovering transition state of decreased orientating gravitational

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force. Two differently natured atoms bind (adhere) to each other when they are just in their neutral transition states where certain electron (of gas atom) visualizes the exerting force to its north-sided tip through certain unfilled energy knot (of solid atom) under their appropriate coinciding.

Transition metals govern hard features of coating under affinity to gas atoms because, one is undertaking the force of grounded format and other is undertaking the force of space format resulting into locate their common ground points having mid-points at the level of ground surface. The electron of outer ring belonging to gas atom (N-atom) reacts to develop TiN by having another clamp of energy knot clamped by the unfilled state of outer ring belonging to solid atom (Ti-atom).

At the time of recovering transition state of Ti-atoms, they are just at the substrate surface, thus, they react to N-atoms, which are also just at substrate surface at the instant of recovering transition state. Ti-atoms just on landing undertake less expansion of their lattice as compared to Ti-atoms already landed resulting into devise the unit (primitive) cell of hard coating when under their appropriate coinciding where N-atoms are incorporated in their interstitial sites. This is the cause that hard coating presents the increased elastic behavior and the decreased plastic behavior.

Appropriate vacuum conditions and high power enhance the hardness level of deposited coatings. Hard coatings introduce certain properties and application due to the developing of non-regular structure where they involved the non-conserved energy, thus, engaging the non-conservative forces to sustain their structure. But, they are not overwhelming forever where their force-energy behaviors may be affected. So, the lifetime of hard coatings depends on their developing strategies along with nature of application. Beside that hard coatings enable one to explore different phenomena of materials and their counterparts, so, opening many new areas of diversified research.

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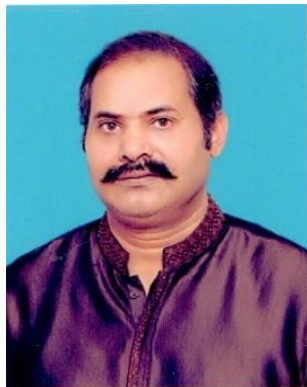
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